L Number	Hits	Search Text	DB	Time stamp
-	1	4300184.pn.	USPAT	2002/02/25 14:26
_	4	chip same (indicia or marking\$) same transparent same cover	USPAT	2002/02/25 14:29
_	39	chip same (indicia or marking\$) same cover	USPAT	2002/02/25 14:35
-	62	(semiconductor or chip) same label\$ same cover	USPAT	2002/02/25 14:43
-			USPAT	
-	0	235/454.pn.		2002/02/25 14:43
. .	1047	235/454.ccls.	USPAT	2002/02/25 14:43
_	11	235/454.ccls. and (label same cover)	USPAT	2002/02/25 14:48
ļ	0	235/454.ccls. and (lin.in)	USPAT	2002/02/25 14:48
-	2	235/454.ccls. and (lee.in.)	USPAT	2002/02/25 14:50
	_		USPAT	2002/02/25 15:07
-	579	(semiconductor or ic or "integrated circuit" or chip or electronic or device) same (cover or encapsul\$ or coat\$ or layer or	USPAT	2002/02/25 15.07
		packag\$) same transparent same (indicia or label or		
		marking\$)		000000000000000000000000000000000000000
-	396	(semiconductor or ic or "integrated circuit" or chip or device)	USPAT	2002/02/25 15:11
		same (cover or encapsul\$ or coat\$ or layer or packag\$) same		
		(indicia or label or mark\$) same identification		
	144	(semiconductor or ic or "integrated circuit" or chip) same	USPAT	2002/02/25 15:21
-	144	(Semiconductor of ic of integrated circuit of chip) same	001 71	2002/02/20 10:21
i i		(cover or encapsul\$ or coat\$ or layer or packag\$) same		
		(indicia or label or mark\$) same identification		
-	40592	(semiconductor or ic or "integrated circuit" or chip) same	USPAT	2002/02/25 15:22
i .		(encapsul\$ or packag\$)		į
1	9474	(semiconductor or ic or "integrated circuit" or chip) same	USPAT	2002/02/25 15:41
·	94/4		00.71	2002/02/20 10:41
1		(encapsul\$)		0000100105 45 45
ı -	136	(transmissive or transparent) same (marking\$ or indicia) same	USPAT	2002/02/25 15:45
		surface same (chip or ic or circuit)		
i _	4	chip same (label or marking or indicia) same (embed\$ or	USPAT	2002/02/25 15:52
1	7	embos\$ or form\$) same surface same cover	00	
			LICDAT	2002/02/25 45:52
-	75	chip same (label or marking or indicia) same (embed\$ or	USPAT	2002/02/25 15:52
		embos\$ or imprint\$)		
_	18	chip same (label or marking or indicia) same (embed\$ or	USPAT	2002/02/25 15:55
1		embos\$ or imprint\$) same identif\$		
	11266	(circuit or chip or semiconductor) same (label or marking or	USPAT	2002/02/25 16:00
-	11366		USFAI	2002/02/23 10:00
		indicia)		
-	1372	((circuit or chip or semiconductor) same (label or marking or	USPAT	2002/02/25 15:59
		indicia)) and transparent and cover\$	į	
i _	59983	(circuit or chip or semiconductor) same (label or marking or	USPAT	2002/02/25 16:02
	33303		00.71.	
		indicia or code)	LIODAT	0000/00/05 40:00
-	1052	((circuit or chip or semiconductor) same (label or marking or	USPAT	2002/02/25 16:06
		indicia or code)) and transparent and cover\$ and transmi\$		
		and mark\$ and identif\$		
ł _	227	((circuit or chip or semiconductor) same (label or marking or	USPAT	2002/02/25 16:14
-	221		00.71.	2002/02/20 10:11
		indicia)) and transparent and cover\$ and transmi\$ and mark\$		1
		and identif\$		
-	59	engrave\$ same surface same indicia and (chip or circuit or	USPAT	2002/02/25 16:19
		semiconductor)		į.
_	3008	(engrave\$ or form\$ or emboss) and (markings or indicia or	USPAT	2002/02/25 16:22
-	3000		001711	1 202.02.20 10.22
		code\$) same surface same (chip or circuit or semiconductor)		0000/00/05 40/04
-	422	(engrave\$ or form\$ or emboss) and (markings or indicia or	USPAT	2002/02/25 16:24
		code\$) same surface same (chip or circuit or semiconductor)		
		and 235/\$.ccls.		
	47	(engrave\$ or form\$ or emboss\$) and (marking\$ or indicia or	USPAT	2002/02/25 16:48
-	47	(engraves or forms of embosss) and (markings of indicia of	001 71	2002/02/20 10:40
		code\$) same surface same (chip or circuit or semiconductor)	İ	
		and 235/454.ccls.	<u> </u>	
_	456	(engrave\$ or form\$_or_emboss\$_or_etch\$)-and-(marking\$-or-	USPAT-	2002/02/25 16:52
		indicia or code\$) same surface same (chip or circuit or		
		semiconductor) same identif\$	LIODAT	0000/00/05 47:00
-	23	(engrave\$ or form\$ or emboss\$ or etch\$) and (marking\$ or	USPAT	2002/02/25 17:02
		indicia or code\$) same surface same (chip or circuit or		1
		semiconductor) same identif\$ and (transparent same cover)		
	4-	/anarouse or forme or ambasse or stable or record)	USPAT	2002/02/25 17:34
-	47	(engrave\$ or form\$ or emboss\$ or etch\$ or record) and	USPAI	2002/02/20 17.34
		(marking\$ or indicia or code\$ or data or information) same		
		surface same (chip or circuit or semiconductor) same identif\$	1	1
		and (transparent same cover)		
		and (transparent same cover)	1	

-	426	(engrave\$ or form\$ or emboss\$ or etch\$ or record) and	USPAT	2002/02/25 17:43
		(marking\$ or indicia or code\$ or data or information) same surface same (chip or circuit or semiconductor) same identif\$		
		and cover		
_	65	(engrave\$ or form\$ or emboss\$ or etch\$ or record) and	USPAT	2002/02/25 17:47
-		(marking\$ or indicia or code\$ or data or information) same	ļ	
. =		surface same (chip or circuit or semiconductor) same identif\$		
		same cover	LICDAT	
-	347	color same (barcode or "bar code") same identif\$	USPAT USPAT	2002/02/26 09:32 2002/02/26 09:35
-	48	color\$ adj3 (barcode or "bar code") same identif\$ (color and (barcode or "bar code")).ti.	USPAT	2002/02/26 09:36
-	5 23	(color and (barcode or bar code)).ti.	USPAT	2002/02/26 09:38
-	1246	"bar code" same color	USPAT	2002/02/26 09:38
-	332	"bar code" same color and 235/\$.ccls.	USPAT	2002/02/26 09:41
•	15	(("bar code" or tag or label) and color).ti.	USPAT	2002/02/26 09:47
	23	"colored barcode" or "colored bar code"	USPAT	2002/02/26 10:44
•	4	"microlabel" same color\$	USPAT	2002/02/26 10:52
•	1	5346738.pn. and bar	USPAT	2002/02/26 11:23
-	5039	(cover same transparent) and (code or label or tag or indicia)	USPAT	2002/02/26 11:23
-	1901	(transparent adj3 cover) and (code or label or tag or indicia)	USPAT	2002/02/26 11:26
•	525	(transparent adj3 cover) same ("bar code" or tag or indicia or label)	USPAT	2002/02/26 11:32
	13	(transparent adj3 cover) same ("bar code") and chip	USPAT	2002/02/26 11:36
	27	("transparent cover") same ("bar code")	USPAT	2002/02/26 11:39
	81	cover same ("bar code") same protect\$	USPAT	2002/02/26 11:39
•	26	cover same ("bar code") same protect\$ same (clear or	USPAT	2002/02/26 11:46
-	44	transparent) cover same ("bar code" or indicia) same protect\$ same	USPAT	2002/02/26 11:58
	44	(semiconductor or circuit or chip) cover same protect\$ same ("bar code" or barcde or indicia) same (semiconductor or circuit or chip)	USPAT	2002/02/26 11:58
	85	cover same protect\$ same (semiconductor or circuit or chip) same identif\$	USPAT	2002/02/26 11:59
	13	cover same protect\$ same (semiconductor or circuit or chip) same identif\$ same (transparent or translucent)	USPAT	2002/02/26 12:58
_	1	5970321.pn.	USPAT	2002/02/26 13:00
•	1	(csp or ("chip scale packag\$")) same (protect\$ or cover) same	USPAT	2002/02/26 13:04
		(transparent or clear or translucent)		
-	2	(csp or ("chip scale package")) same (protect\$ or cover) same	USPAT	2002/02/26 13:07
	2	(transparent or clear or translucent) (csp or ("chip scale")) same (protect\$ or cover) same	USPAT	2002/02/26 13:12
-	2	(transparent or clear or translucent)		,
-	1	5118369.pn. and code	USPAT	2002/02/26 13:25
-	31386	"protective layer" or "protective coating" same code same	USPAT	2002/02/26 13:27
		(chip or circuit)	LICOAT	2002/02/26 12:27
-	6407	(protect\$ or encapsul\$) same (circuit or chip) same cover	USPAT	2002/02/26 13:27 2002/02/26 13:34
	128	(protect\$ adj layer) same indicia (protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 13:47
	6369	semiconductor) and (mold\$ or print\$ or glb) and (transparent	001 71	2002/02/20 10.47
		or translucent)	LICDAT	2002/02/06 42:44
	57	(protect\$ adj layer) same indicia same (mold\$ or print\$ or glob)	USPAT	2002/02/26 13:41
	14935	(protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 14:01
		semiconductor) same (mold\$ or print\$ or glob or epoxy same transparent)		
-	2634	(protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 13:59
_	13	semiconductor) same identif\$ (protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 13:57
	.5	semiconductor) same identif\$ same transparent same cover		
-	13	(protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 14:00
		semiconductor) same identif\$ same transparent same cover		000000000011111
-	8	(protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 14:11
		semiconductor) same (mold\$ or print\$ or glob or epoxy) same		
		transparent same cover same identif\$ (protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 14:13
	336			

-	25	(protect\$ or encapsul\$) same (chip or circuit or	USPAT	2002/02/26 14:32
		semiconductor) same (code or indicia or label) same identif\$		
		and cover and transparent		
-	1	5279690.pn. and transparent	USPAT	2002/02/26 14:57
-	1070	mylar same color\$	USPAT	2002/02/26 14:57
-	5	mylar adj color\$	USPAT	2002/02/26 15:09
	• 0	5118369.pn. and silicon	USPAT	2002/02/26 15:24
_	50	chip same color same identification	USPAT	2002/02/26 15:44
-	1489		USPAT	2002/02/26 15:45
-	24	identif\$ adj3 (semiconductor or circuit) adj3 color	USPAT	2002/02/26 15:49
-	74	identif\$ same semiconductor same color	USPAT	2002/02/26 16:01
-	3514	color adj2 code	USPAT	2002/02/26 16:03
-	824	(color adj2 code) same identif\$	USPAT	2002/02/26 16:03
-	67	(color adj2 code) same identif\$ same (circuit or chip or	USPAT	2002/02/26 16:10
		semiconductor)		
-	19	"color coded" adj3 (circuit or semiconductor or chip)	USPAT	2002/02/26 16:11